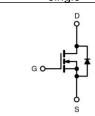
## **Sinai Power Technologies**

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### **N-channel Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> max. at 25°C (Ω)	V <sub>GS</sub> =10V	4.8		
Q <sub>g</sub> max. (nC)	2	2		
Q <sub>gs</sub> (nC)	3	3		
Q <sub>gd</sub> (nC)	6	3		
Configuration	single			



Schematic diagram

### **Features**

- I<sub>D</sub>=3A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- 100% Avalanche Tested
- RoHS compliant

### **Applications**

- Switching Mode Power Supplies (SMPS)
- **PWM Motor Controls**
- DC to DC Converters
- **HID Lighting**
- **Bridge Circuits**

ORDERING INFORMATION				
Device	SPD3N80G			
Device Package	TO-252			
Marking	3N80G			

ABSOLUTE MAXIMUM RATINGS (Tc = 25°C, unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Drain to Source Voltage	V <sub>DSS</sub>	800	V		
Continuous Drain Current (@T <sub>C</sub> =25°C)		3	Α		
Continuous Drain Current (@T <sub>C</sub> =100°C)	I <sub>D</sub>	1.8	А		
Drain current pulsed (2)	I <sub>DM</sub>	12	А		
Gate to Source Voltage	V <sub>GS</sub>	30	V		
Single pulsed Avalanche Energy (3)	E <sub>AS</sub>	67	mJ		
Peak diode Recovery dv/dt (4)	dv/dt	6	V/ns		
Total power dissipation (@T <sub>C</sub> =25°C)		131	W		
Derating Factor above 25°C	P <sub>D</sub>	1.05	W/ºC		
Operating Junction Temperature & Storage Temperature	T <sub>STG</sub> , T <sub>J</sub>	-55 to + 150	°C		
Maximum lead temperature for soldering purpose	TL	260	°C		

#### Notes

- 1. Drain current is limited by maximum junction temperature.
- 2. Repetitive rating : pulse width limited by junction temperature.
- 3. L = 15mH,  $I_{AS}$  =3A,  $V_{DD}$  = 50V,  $R_G$ =25 $\Omega$ , Starting at  $T_J$  = 25°C 4.  $I_{SD}$  ≤ 3A, di/dt = 100A/us,  $V_{DD}$  ≤ BV<sub>DSS</sub>, Starting at  $T_J$  =25°C

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THERMAL CHARACTERISTICS				
Parameter	Symbol	Value	Unit	
Thermal resistance, Junction to case	R <sub>thjc</sub>	0.95	°C/W	
Thermal resistance, Junction to ambient	R <sub>thja</sub>	80.2	°C/W	

ELECTRICAL CHARACTERISTICS (Tc = 25°C unless otherwise specified)						
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain to source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	800			V
Breakdown voltage temperature coefficient	ΔBV <sub>DSS</sub> / ΔTJ	I <sub>D</sub> =250uA, referenced to 25°C		0.42		V/°C
Drain to a curso lookage current		V <sub>DS</sub> =800V, V <sub>GS</sub> =0V			1	uA
Drain to source leakage current	I <sub>DSS</sub>	V <sub>DS</sub> =640V, T <sub>C</sub> =125°C			50	uA
Gate to source leakage current, forward	1	V <sub>GS</sub> =30V, V <sub>DS</sub> =0V			100	nA
Gate to source leakage current, reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA
On Characteristics						
Gate threshold voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2		4	V
Drain to source on state resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1.5A		4	4.8	Ω
Forward Transconductance	Gfs	$V_{DS} = 30 \text{ V}, I_{D} = 1.5 \text{ A}$		3.6		S
Dynamic Characteristics						
Input capacitance	C <sub>iss</sub>			530		
Output capacitance	Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz		62		pF
Reverse transfer capacitance	C <sub>rss</sub>			15		
Turn on delay time	t <sub>d(on)</sub>			11		
Rising time	tr	-V <sub>DS</sub> =400V, I <sub>D</sub> =3A,R <sub>G</sub> =25Ω		31		ns
Turn off delay time	t <sub>d(off)</sub>			52		115
Fall time	t <sub>f</sub>			33		
Total gate charge	$Q_g$	V <sub>DS</sub> =640V, V <sub>GS</sub> =10V, I <sub>D</sub> =3A		15		
Gate-source charge	Q <sub>gs</sub>			3		nC
Gate-drain charge	$Q_{gd}$			6		

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS							
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit	
Continuous source current	Is	Integral reverse p-n Junction L diode in the MOSFET			3	Α	
Pulsed source current	I <sub>SM</sub>				12	Α	
Diode forward voltage drop.	V <sub>SD</sub>	I <sub>S</sub> =3A, V <sub>GS</sub> =0V			1.2	V	
Reverse recovery time	T <sub>rr</sub>	I <sub>S</sub> =3A, V <sub>GS</sub> =0V, dI <sub>F</sub> /dt=100A/us		280		ns	
Reverse recovery Charge	Qrr			1.9		uC	



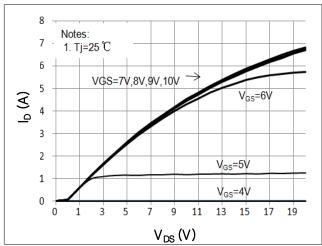


Fig3. Gate charge characteristics

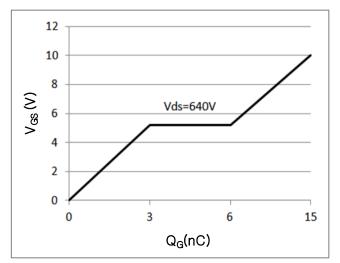


Fig 5. RDS(ON) vs junction temperature

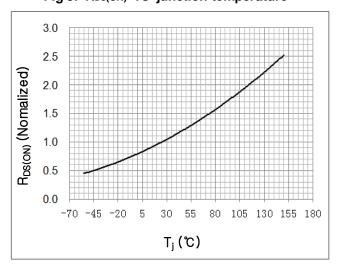


Fig2. Drain-source on-state resistance

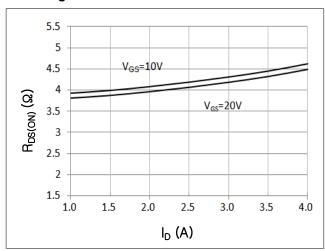
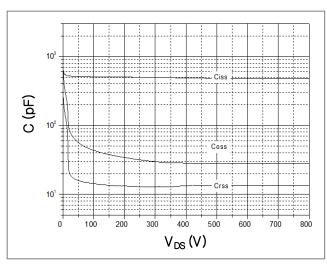
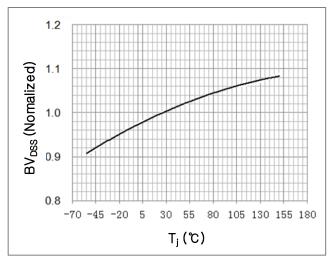


Fig 4. Capacitance Characteristics



BV<sub>DSS</sub> vs junction temperature



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Fig 7. Safe operating area

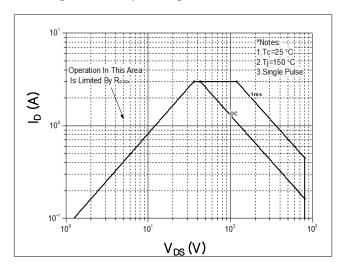


Fig 8. Transient thermal impedance

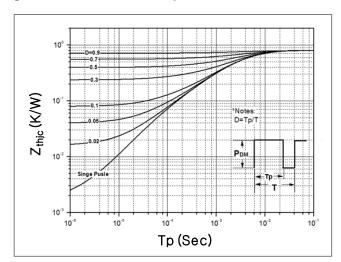


Fig 9. Forward characteristics of reverse diode

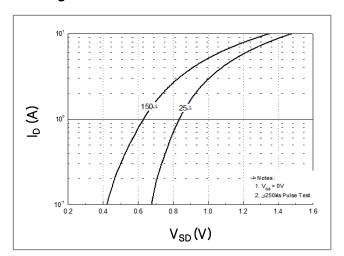
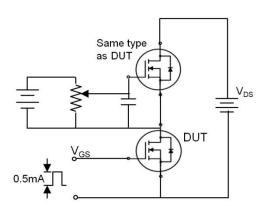
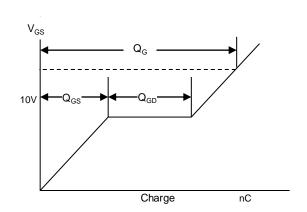
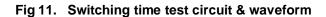


Fig 10. Gate charge test circuit & waveform





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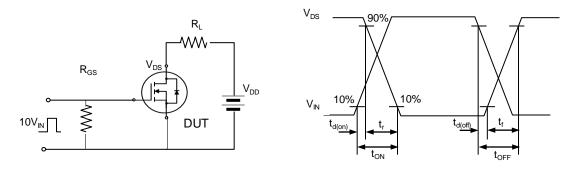


Fig 12. Unclamped Inductive switching test circuit & waveform

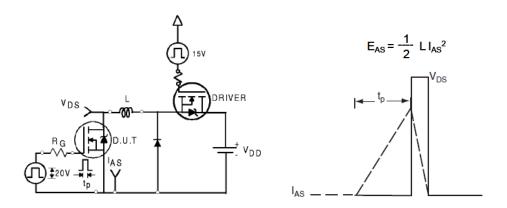
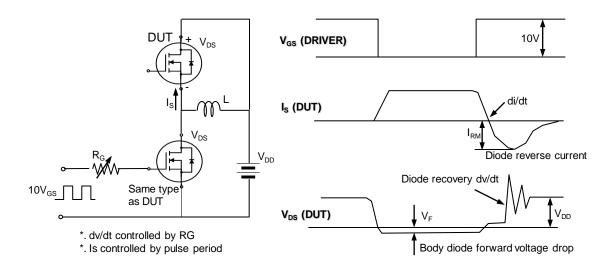


Fig 13. Peak diode recovery dv/dt test circuit & waveform





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